

Layer	Name	Material	Thickness	Constant	Board Layer Stack
1	Top Overlay				
2	Top Solder	Solder Resist	0.40mil	3.5	
3	Top Layer	Copper	2.10mil		
4	Dielectric1	FR-4	14.00mil	4.3	
5	L2	Copper	0.70mil		
6	Dielectric2	FR-4	28.00mil	4.3	
7	L3	Copper	0.70mil		
8	Dielectric 3	FR-4	14.00mil	4.3	
9	Bottom Layer	Copper	2.10mil		
10	Bottom Solder	Solder Resist	0.40mil	3.5	
11	Bottom Overlay				



